GS-770

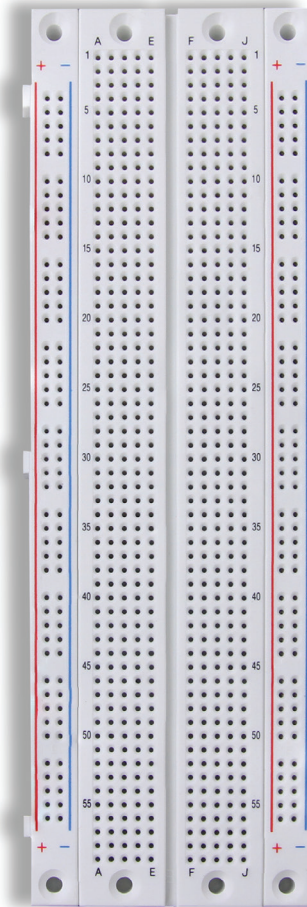## 770 Tie-Point, Solderless Breadboard with bus strip

Applications

The GS-770 is a modular type solderless breadboard that is comprised of the GS-090 bus strip and the GS-590 breadboard. It is a great way to prototype low frequency or DC powered circuits. They are ideal for:

- Educational labs
- Hobbyists

Features

- 770 Tie-points
- ABS plastic body
- Round hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 7 total 16-pin ICs
- Measures 5.6 x 16.5 x 1.0 cm
- Weighs 71 g
- Maximum capacity of 1.5 A at 36 V
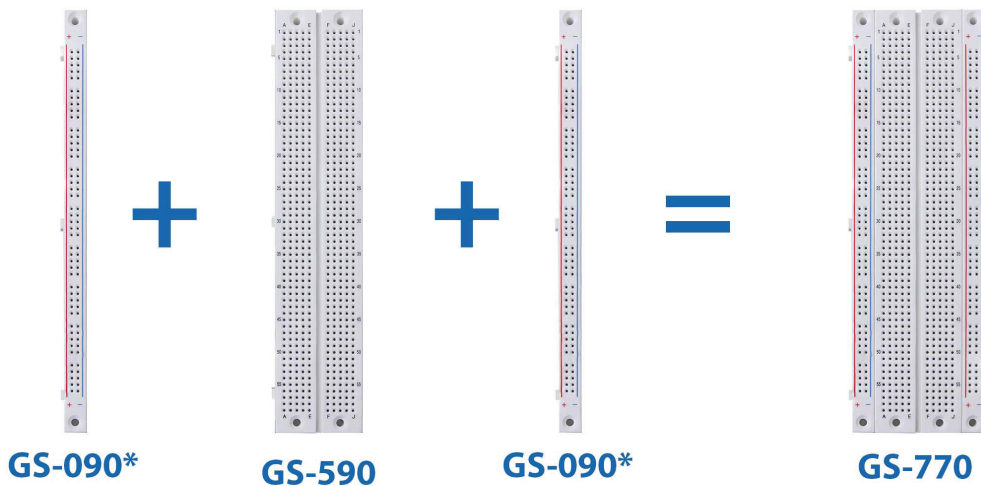- RoHS compliant
- Three-year warranty

GS-770

770 Tie-Point, Solderless Breadboard with bus strip

Applications

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GS-770 Components

GS-090* + GS-590 + GS-090* = GS-770

*The GS-090 is sold as a pack of two

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A Cal Test Electronics Company

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22820 Savi Ranch Parkway
Yorba Linda, CA 92887
800-572-1028
globalspecialties.com